

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSV)

2SK3499

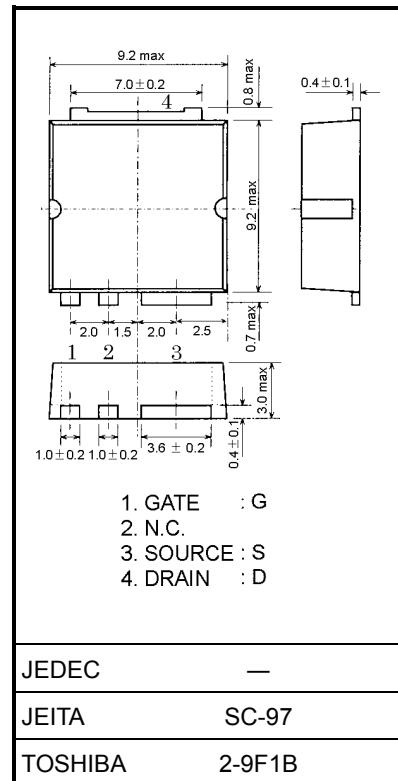
Switching Regulator and DC-DC Converter Applications
Motor Drive Applications

Unit: mm

- Low drain-source ON resistance: $R_{DS(ON)} = 0.4 \Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 8.0 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = 100 \mu\text{A}$ (max) ($V_{DS} = 400 \text{ V}$)
- Enhancement-model: $V_{th} = 2.0$ to 4.0 V ($V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$)

Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	V_{DSS}	400	V
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)	V_{DGR}	400	V
Gate-source voltage	V_{GSS}	± 30	V
Drain current	DC (Note 1)	I_D	A
	Pulse (Note 1)	I_{DP}	
Drain power dissipation ($T_c = 25^\circ\text{C}$)	P_D	80	W
Single pulse avalanche energy (Note 2)	E_{AS}	360	mJ
Avalanche current	I_{AR}	10	A
Repetitive avalanche energy (Note 3)	E_{AR}	8	mJ
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature range	T_{stg}	-55 to 150	$^\circ\text{C}$



Weight: 0.74 g (typ.)

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th}(ch-c)$	1.56	$^\circ\text{C}/\text{W}$

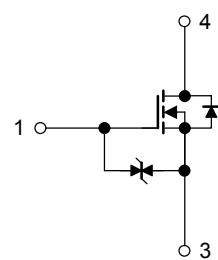
Note 1: Please use devices on condition that the channel temperature is below 150°C .

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^\circ\text{C}$ (initial), $L = 5.85 \text{ mH}$, $R_G = 25 \Omega$, $I_{AR} = 10 \text{ A}$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device. Please handle with caution.

Circuit Configuration



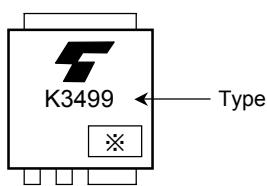
Electrical Characteristics ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit	
Gate leakage current	I_{GSS}	$V_{GS} = \pm 25\text{ V}, V_{DS} = 0\text{ V}$	—	—	± 10	μA	
Drain-source breakdown voltage	$V_{(\text{BR})\text{ GSS}}$	$I_G = \pm 10\text{ }\mu\text{A}, V_{DS} = 0\text{ V}$	± 30	—	—	V	
Drain cut-OFF current	I_{DSS}	$V_{DS} = 400\text{ V}, V_{GS} = 0\text{ V}$	—	—	100	μA	
Drain-source breakdown voltage	$V_{(\text{BR})\text{ DSS}}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	400	—	—	V	
Gate threshold voltage	V_{th}	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	2.0	—	4.0	V	
Drain-source ON resistance	$R_{DS}\text{ (ON)}$	$V_{GS} = 10\text{ V}, I_D = 5.0\text{ A}$	—	4.0	0.55	Ω	
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 10\text{ V}, I_D = 5.0\text{ A}$	4.0	0.8	—	S	
Input capacitance	C_{iss}	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	1340	—	pF	
Reverse transfer capacitance	C_{rss}		—	160	—		
Output capacitance	C_{oss}		—	490	—		
Switching time	Rise time	t_r	 V_{GS} 10 V V_{GS} 0 V $I_D = 5\text{ A}$ $R_L = 40\Omega$ $V_{DD} \approx 200\text{ V}$ Duty $\leq 1\%$, $t_w = 10\text{ }\mu\text{s}$	—	22	—	ns
	Turn-ON time	t_{on}		—	60	—	
	Fall time	t_f		—	32	—	
	Turn-OFF time	t_{off}		—	140	—	
Total gate charge (gate-source plus gate-drain)	Q_g	$V_{DD} \approx 320\text{ V}, V_{GS} = 10\text{ V}, I_D = 10\text{ A}$	—	34	—	nC	
Gate-source charge	Q_{gs}		—	18	—		
Gate-drain ("miller") charge	Q_{gd}		—	16	—		

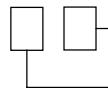
Source-Drain Ratings and Characteristics ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	I_{DR}	—	—	—	10	A
Pulse drain reverse current (Note 1)	I_{DRP}	—	—	—	40	A
Forward voltage (diode)	V_{DSF}	$I_{DR} = 10\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.7	V
Reverse recovery time	t_{rr}	$I_{DR} = 10\text{ A}, V_{GS} = 0\text{ V},$ $dI_{DR}/dt = 100\text{ A}/\mu\text{s}$	—	350	—	μs
Reverse recovery charge	Q_{rr}	—	—	3.6	—	μC

Marking



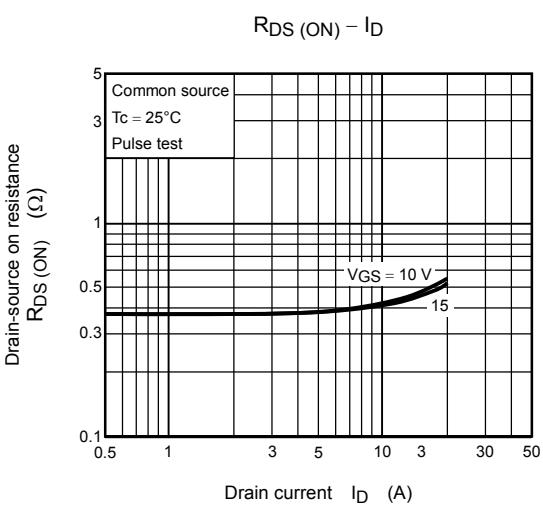
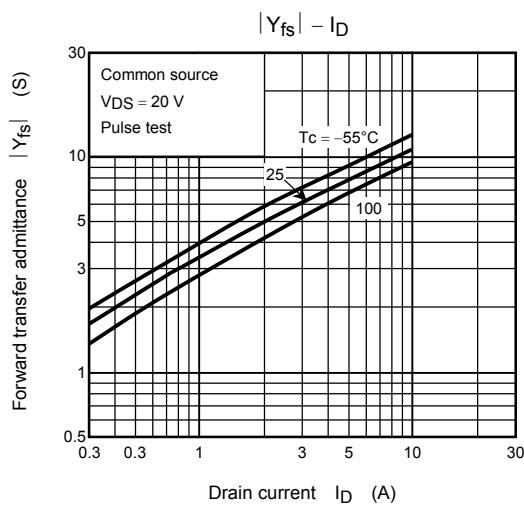
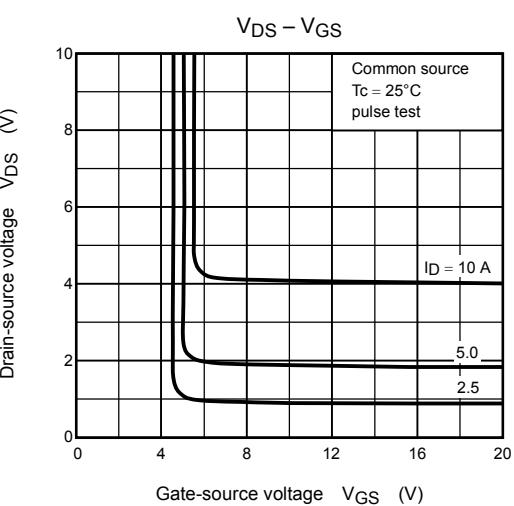
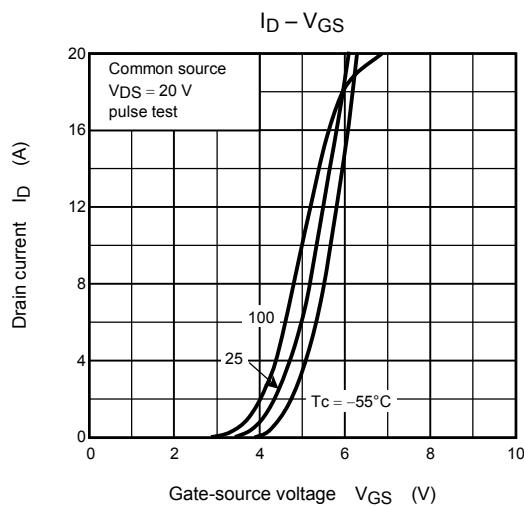
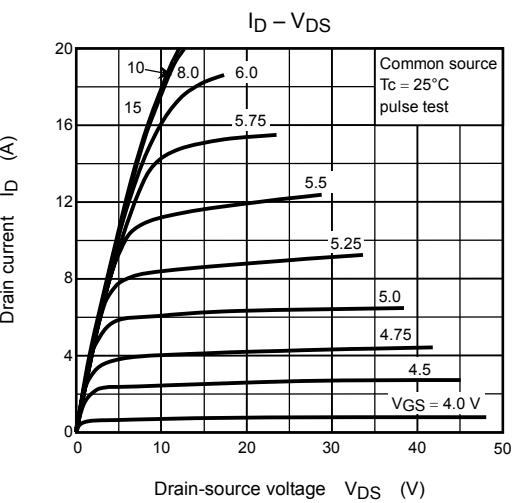
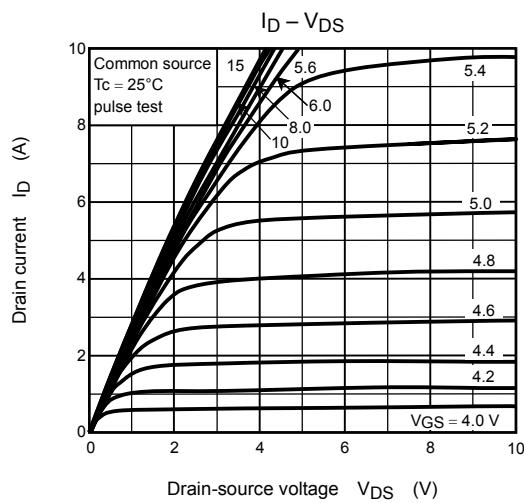
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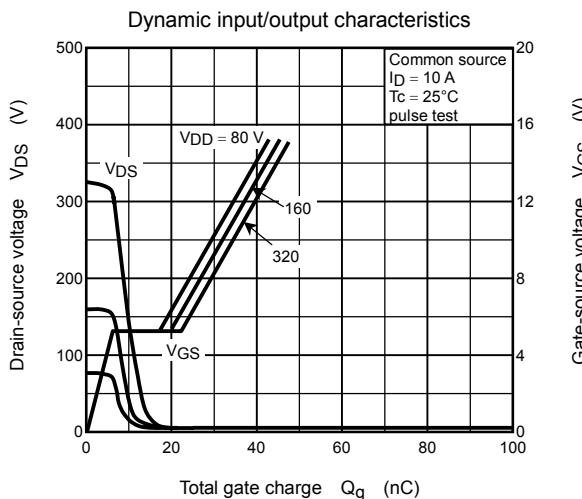
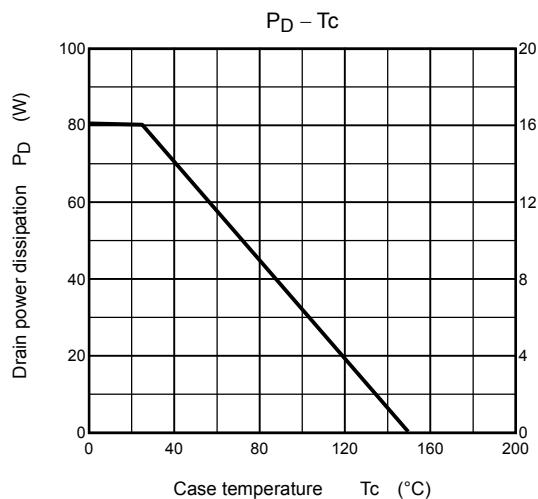
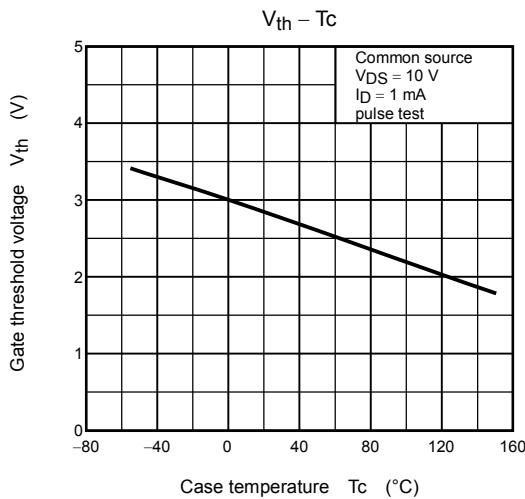
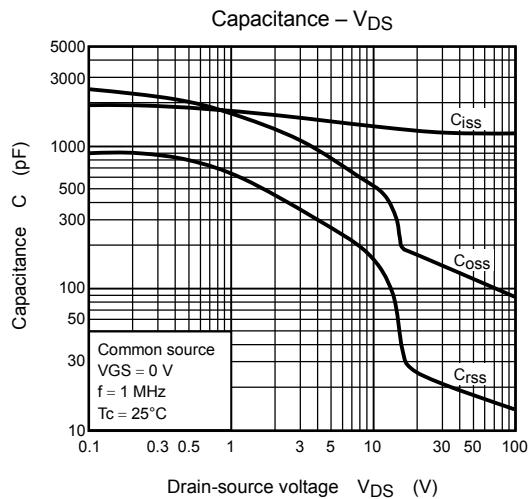
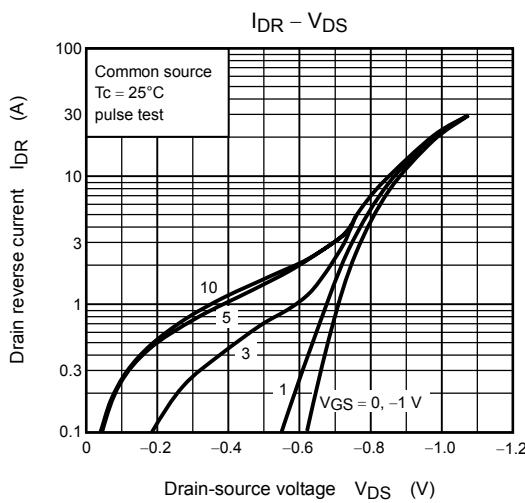
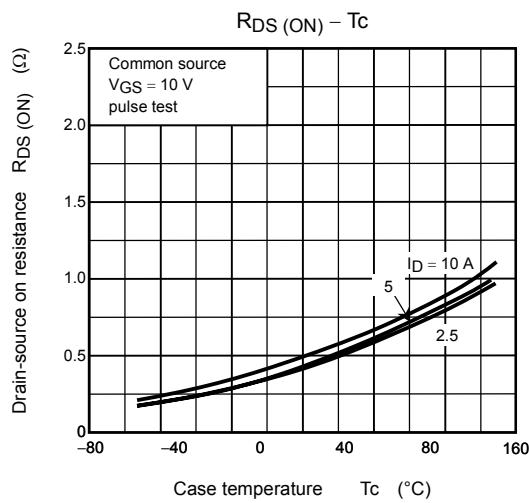


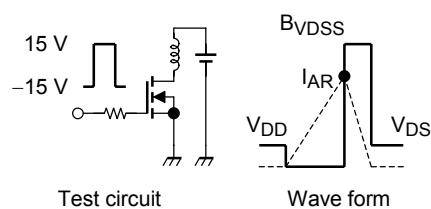
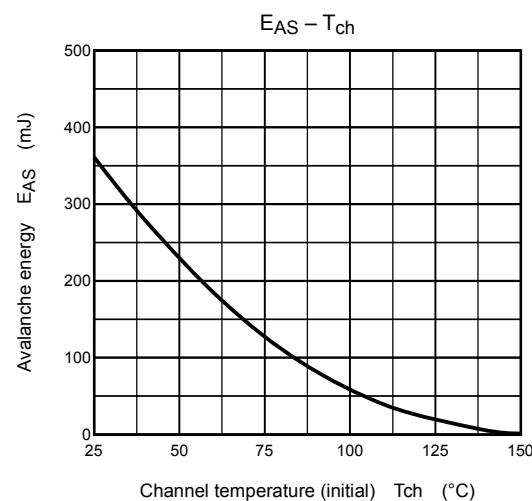
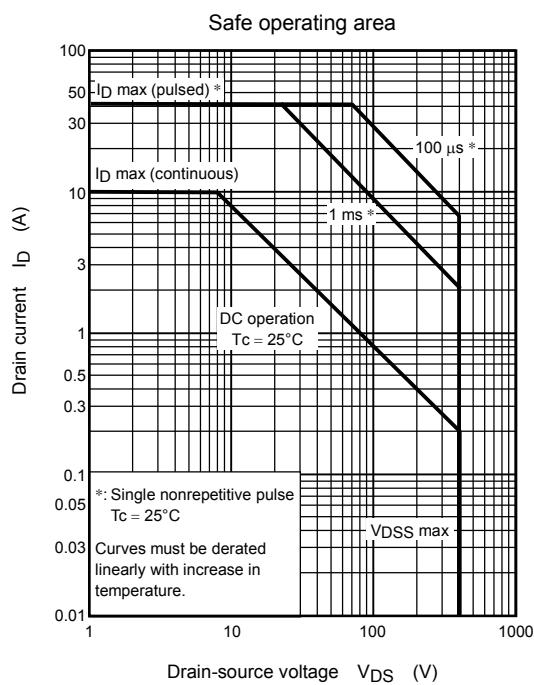
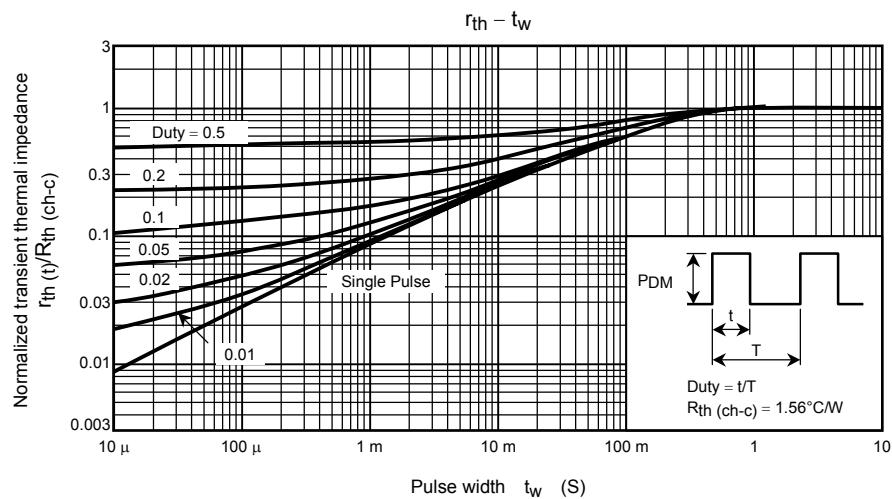
Month (starting from alphabet A)

Year

(last number of the christian era)







$$R_G = 25 \Omega$$

$$V_{DD} = 90 \text{ V}, L = 5.85 \text{ mH}$$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

RESTRICTIONS ON PRODUCT USE

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